

Characteristic		Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage		V_{RM}	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	80	V
RMS Reverse Voltage		V _{R(RMS)}	57	V
Forward Continuous Current (Note 5)		I _{FM}	500	mA
Average Rectified Output Current (Note 5)		lo	250	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0μs @ t = 1.0s	I _{FSM}	4.0 1.0	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P_{D}	150	mW
Thermal Resistance Junction to Ambient (Note 5)	$R_{ hetaJA}$	833	°C/W
Operating and Storage Temperature Range	T_J , T_{STG}	-65 to +150	°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition		
Reverse Breakdown Voltage (Note 6)	$V_{(BR)R}$	80	1	V	$I_R = 2.5 \mu A$		
		0.62	0.72	V	$I_F = 5.0 \text{mA}$		
Forward Voltage	VF	_	0.855		$I_F = 10mA$		
Polward voltage	٧F	_	1.0		$I_F = 100 \text{mA}$		
		_	1.25		$I_F = 150 \text{mA}$		
	I _R —		100	nA	V _R = 70V		
Leakage Current (Note 6)			50	μΑ	$V_R = 75V, T_J = 150^{\circ}C$		
Leakage Current (Note o)		IR	IR	_	30	μΑ	V _R = 25V, T _J = 150°C
			25	nA	$V_R = 20V$		
Total Capacitance	C _T		3.5	pF	$V_R = 6V, f = 1.0MHz$		
Reverse Recovery Time	t _{rr}	_	4.0	ns	$V_R = 6V$, $I_F = 5mA$		

Notes: 5. Device mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com.

6. Short duration pulse test used to minimize self-heating effect.

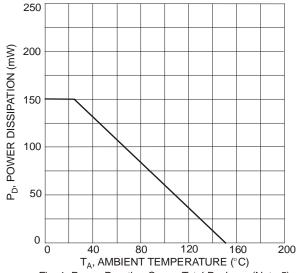


Fig. 1 Power Derating Curve, Total Package (Note 5)

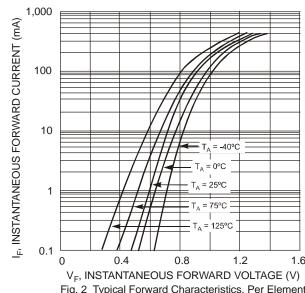
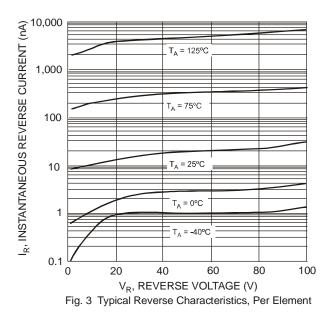


Fig. 2 Typical Forward Characteristics, Per Element





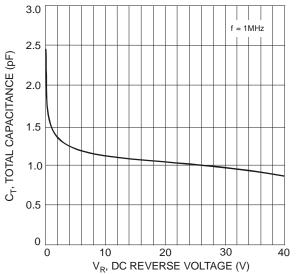
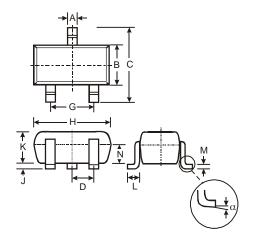


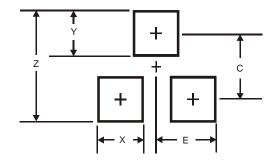
Fig. 4 Total Capacitance vs. Reverse Voltage, Per Element

Package Outline Dimensions



SOT-523			
Dim	Min	Max	Тур
Α	0.15	0.30	0.22
В	0.75	0.85	0.80
С	1.45	1.75	1.60
D		_	0.50
G	0.90	1.10	1.00
Н	1.50	1.70	1.60
J	0.00	0.10	0.05
K	0.60	0.80	0.75
L	0.10	0.30	0.22
M	0.10	0.20	0.12
N	0.45	0.65	0.50
α	0°	8°	
All Dimensions in mm			

Suggested Pad Layout



Dimensions	Value (in mm)
Z	1.8
Х	0.4
Y	0.51
С	1.3
Е	0.7



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